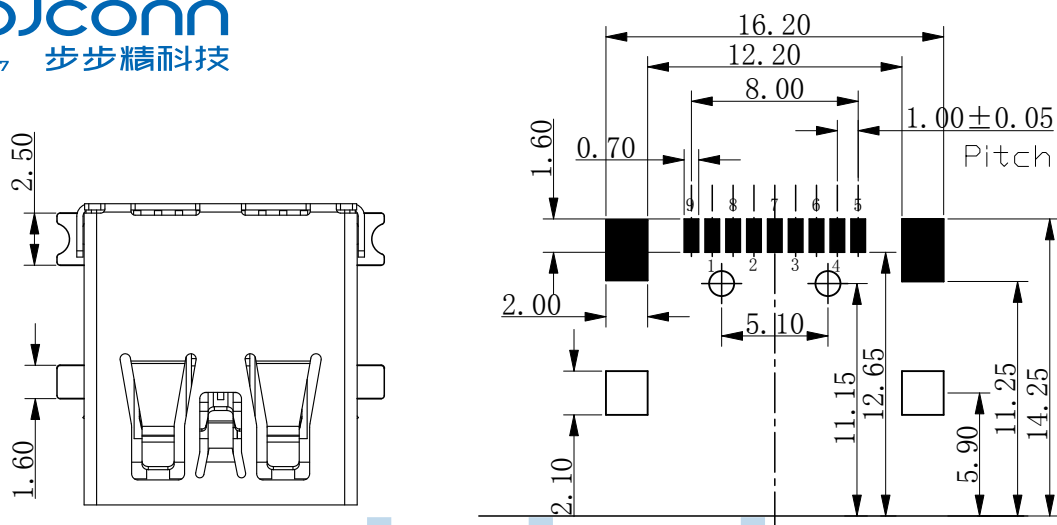


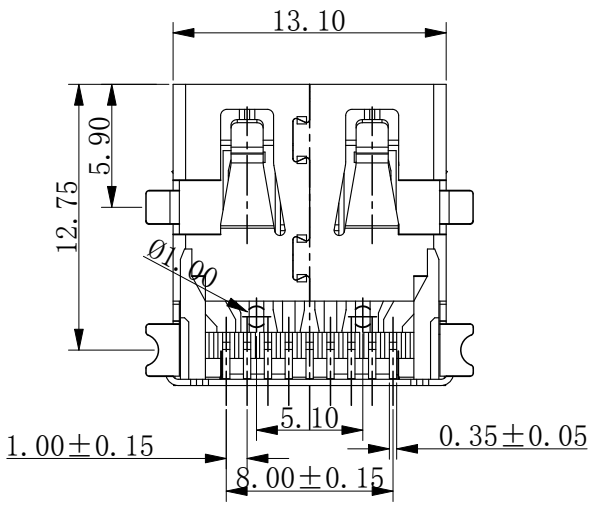
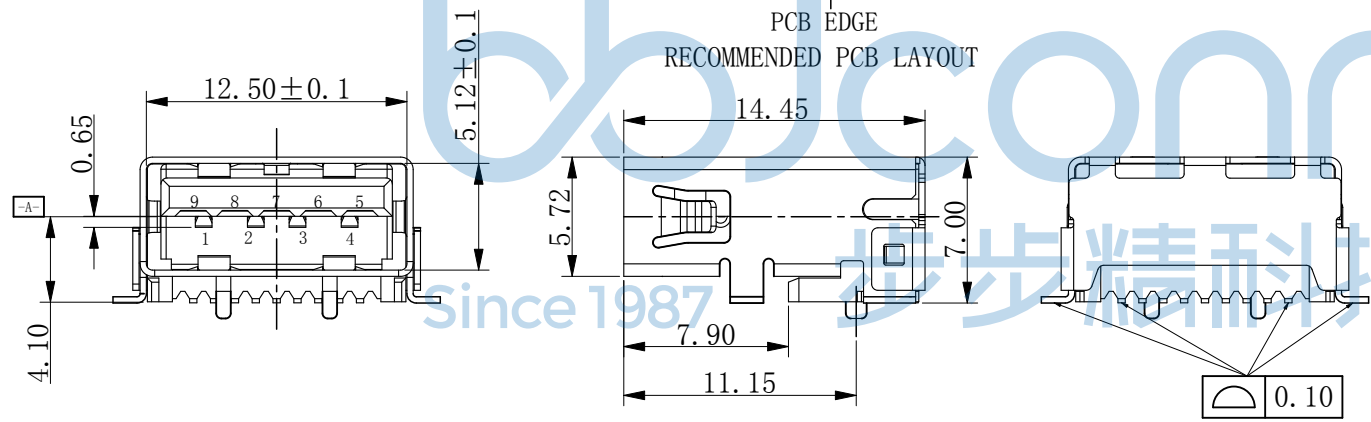
REV.	ECN NO.	CONTENT	DATE	ENGINEER
AO		Initial release	/	TSP

NOTE:

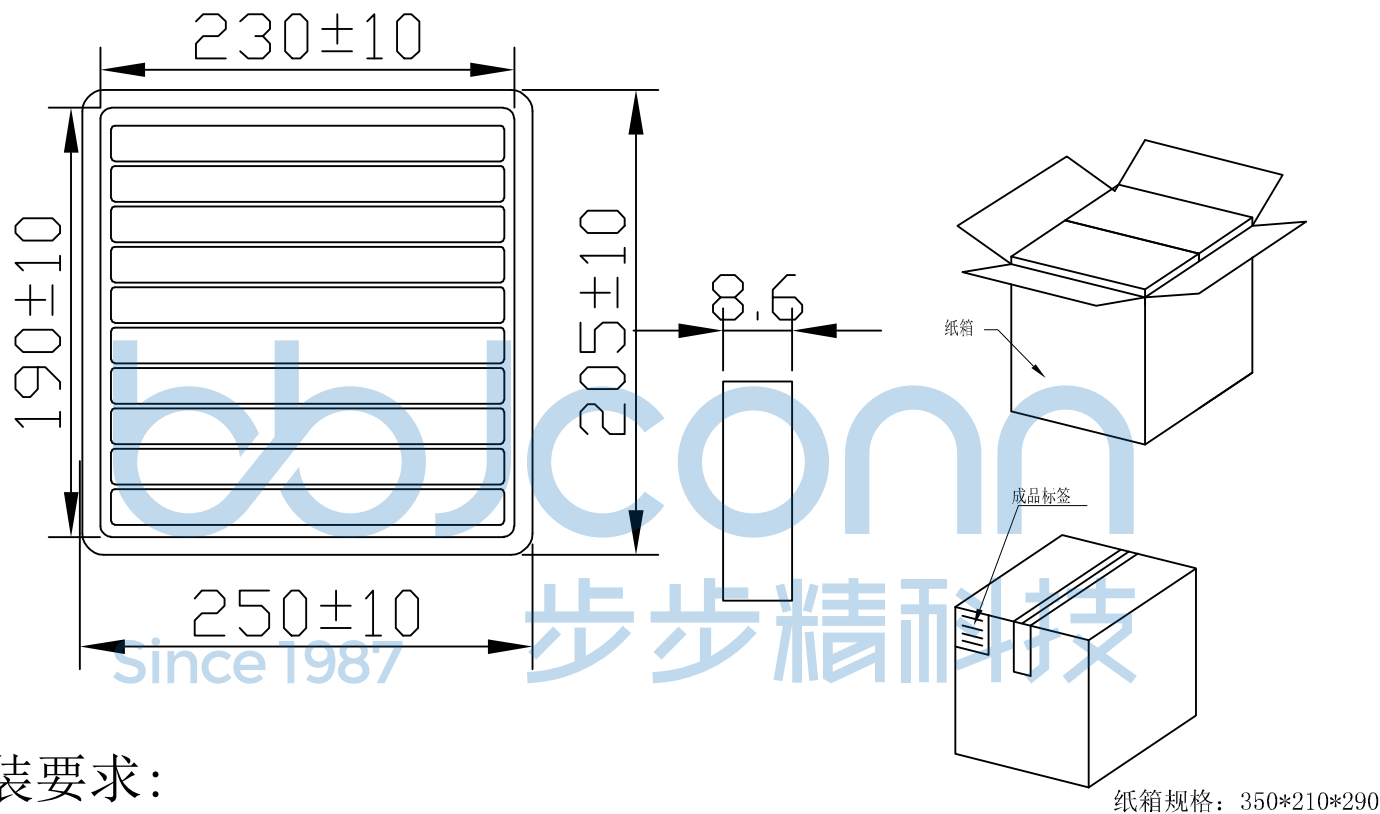
1. MATERIAL:
 - 1.1 INSULATOR:LCP/PBT UL 94V-0
 - 1.2 CONTACT:BRONZE C5191
 - 1.3 SHELL:BRASS C2680/SPCC
2. ELECTRICAL CHARACTERISTICS:
 - 2.1 CONTACT RESISTANCE:30mΩ MAXIMUM
 - 2.2 CONTACT CURRENT RATING:1.5A
 - 2.3 DIELECTRIC WITHSTANDING VOLTAGE:100 V AC R. M. S.
 - 2.4 INSULATION RESISTANCE 100 MEGOHMS MIN
 - 2.5 OPERATING TEMPERATURE:-40° C ~ 85° C
- 3 MECHANICAL CHARACTERISTICS:
 - 3.1 MATING FORCE:3.57kgf MAX
 - 3.2 UNMATED FORCE:1.02kgf MIN AFTER TEST
 - 3.3 DURABILITY MANDATORY:1200 CYCLES
4. PLATING
 - 4.1 TERMINAL:
 - 50u" MIN NICKEL ALL OVER
 - 80u"MIN Tin ON SOLDER AREA
 - (1~30)u"Au ON CONTACT AREA
 - 4.2 SHELL:100u"MIN. NICEL ALL OVER



PCB EDGE
RECOMMENDED PCB LAYOUT



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PDWG.NO: 0536-1	APPD. JM_Zheng	NAME: USB 3.0 AF 90度 L=14.45 全贴 带柱 端子SMT 平口 LCP蓝胶 铜壳 吸塑盒	
CHKD. LYX	DR. TSP	PJ. NO.: UB.03.22-32-W002	
		SIZE: A4 DRW NO.:	
		FINISH: SEE NOTES MAT'L.: SEE NOTES	
		SCALE: N/A	REV.: AO UNIT: mm PAGE: 1/2



1. 包装要求:

- 1.1 每盒吸塑盒包装100pcs;
- 1.2 每20盘放一箱, 共计2000PCS;
- 1.3 纸箱外贴上标签。

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PDWG.NO: 0536-1		.X: ±0.38 .XX: ±0.25 .XXX: ±0.13	X': ±3" .X': ±2" .XX': ±1"
APPD.	JM_Zheng	NAME: USB 3.0 AF 90度 L=14.45 全贴 带柱 端子SMT 平口 LCP蓝胶 铜壳 吸塑盒	
CHKD.	LYX	PJ. NO.: UB.03.22-32-W002	
DR.	TSP	SIZE: A4 DRW NO.:	
		FINISH: SEE NOTES	MAT'L.: SEE NOTES
		SCALE: N/A	REV.: A0
		UNIT: mm	PAGE: 2/2